

Dual P-Channel 60-V (D-S) MOSFET

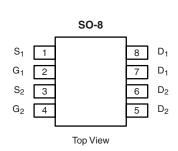
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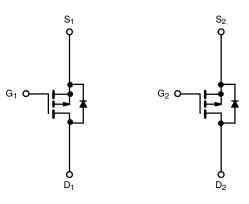
PRODUCT SUMMARY				
V _{DS} (V)	$R_{DS(on)}\left(\Omega\right)$	I _D (A)		
- 60	$0.120 \text{ at V}_{GS} = -10 \text{ V}$	- 3.1		
	0.150 at V _{GS} = - 4.5 V	- 2.8		

FEATURES

- Halogen-free According to IEC 61249-2-21 Definition
- TrenchFET® Power MOSFET
- Compliant to RoHS Directive 2002/95/EC







P-Channel MOSFET

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ABSOLUTE MAXIMUM RATINGS	T _A = 25 °C, unle	ss otherwise r	noted		
Parameter		Symbol	10 s	Steady State	Unit
Drain-Source Voltage		V _{DS}	- 60		V
Gate-Source Voltage		V _{GS}	± 20		
Continuous Dunin Comment /T 450 90\8	T _A = 25 °C	- I _D	- 3.1	- 2.4	
Continuous Drain Current (T _J = 150 °C) ^a	T _A = 70 °C		- 2.6	- 2.0	
Pulsed Drain Current (10 µs Pulse Width)		I _{DM}	- 25		Α
Continuous Source Current (Diode Conduction) ^a		I _S	- 2	- 1.1	
Avalanche Current	L = 0.1 mH	I _{AS}	-	15	
Single Pulse Avalanche Energy	L = U. I IIII	E _{AS}	11		mJ
Martine Brown Bright 199	T _A = 25 °C	D_	2.4	1.4	w
Maximum Power Dissipation ^a	T _A = 70 °C	- P _D	1.7	0.95	
Operating Junction and Storage Temperature Range		T _J , T _{stg}	- 55 to 175		°C

THERMAL RESISTANCE RATINGS					
Parameter		Symbol	Typical	Maximum	Unit
Marrian Institute to Ameliant	t ≤ 10 s	R_{thJA}	53	62.5	
Maximum Junction-to-Ambient ^a	Steady State	□thJA	85	110	°C/W
Maximum Junction-to-Foot	Steady State	R_{thJF}	30	37	

Notes:

a. Surface Mounted on 1" x 1" FR4 board.



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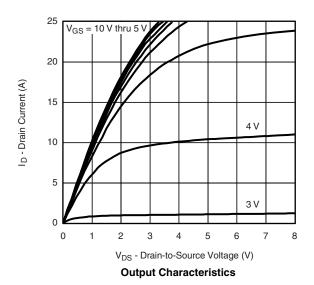
Parameter	Symbol	Test Conditions	Min.	Тур.	Max.	Unit	
Static							
Gate Threshold Voltage	V _{GS(th)}	$V_{DS} = V_{GS}, I_{D} = -250 \mu A$	- 1		- 3	V	
Gate-Body Leakage	I _{GSS}	$V_{DS} = 0 \text{ V}, V_{GS} = \pm 20 \text{ V}$			± 100	nA	
Zava Cata Valtaga Dvain Curvent		V _{DS} = - 60 V, V _{GS} = 0 V			- 1	μА	
Zero Gate Voltage Drain Current	I _{DSS}	V _{DS} = - 60 V, V _{GS} = 0 V, T _J = 70 °C			- 10		
On-State Drain Current ^a	I _{D(on)}	V _{DS} = - 5 V, V _{GS} = - 10 V	- 25			Α	
	В	V _{GS} = - 10 V, I _D = - 3.1 A		0.100	0.120	Ω	
Drain-Source On-State Resistance ^a	R _{DS(on)}	V _{GS} = - 4.5 V, I _D = - 0.2 A		0.126	0.150		
Forward Transconductance ^a	9 _{fs}	V _{DS} = - 15 V, I _D = - 3.1 A		8.5		S	
Diode Forward Voltage ^a	V_{SD}	I _S = - 2 A, V _{GS} = 0 V		- 0.8	- 1.2	V	
Dynamic ^b				L	<u> </u>		
Total Gate Charge	Qg			14.5	22		
Gate-Source Charge	Q_{gs}	$V_{DS} = -30 \text{ V}, V_{GS} = -10 \text{ V}, I_{D} = -3.1 \text{ A}$		2.2		nC	
Gate-Drain Charge	Q_{gd}			3.7			
Gate Resistance	R_{g}	f = 1 MHz		14		Ω	
Turn-On Delay Time	t _{d(on)}			10	15		
Rise Time	t _r	V_{DD} = - 30 V, R_L = 30 Ω		15	22		
Turn-Off Delay Time	t _{d(off)}	$I_D \cong$ - 1 A, V_{GEN} = - 10 V, R_g = 6 Ω		50	75	ns	
Fall Time	t _f			35	55		
Source-Drain Reverse Recovery Time t_{rr} $I_F = -2 A$, $dI/dt = -2 A$		I _F = - 2 A, dI/dt = 100 A/μs		30	50		

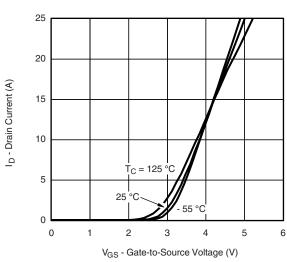
Notes:

- a. Pulse test; pulse width $\leq 300~\mu s,$ duty cycle $\leq 2~\%.$
- b. Guaranteed by design, not subject to production testing.

Stresses beyond those listed under "Absolute Maximum Ratings" may cause permanent damage to the device. These are stress ratings only, and functional operation of the device at these or any other conditions beyond those indicated in the operational sections of the specifications is not implied. Exposure to absolute maximum rating conditions for extended periods may affect device reliability.

TYPICAL CHARACTERISTICS 25 °C, unless otherwise noted





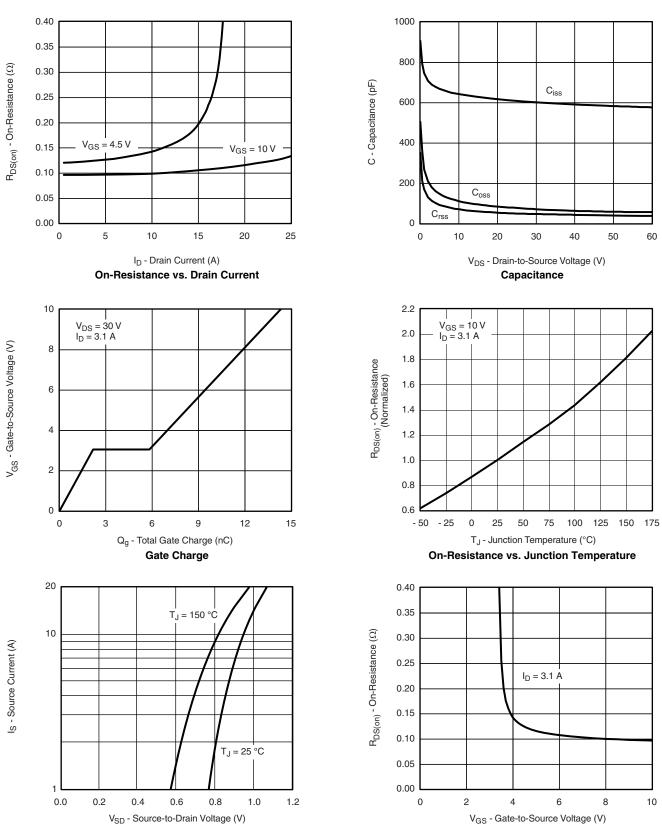
Transfer Characteristics



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TYPICAL CHARACTERISTICS 25 °C, unless otherwise noted

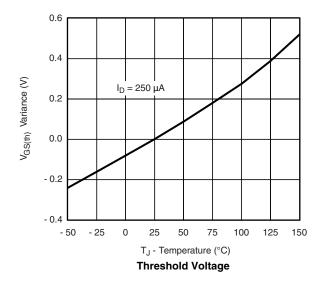
Source-Drain Diode Forward Voltage

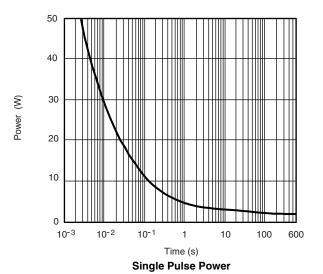


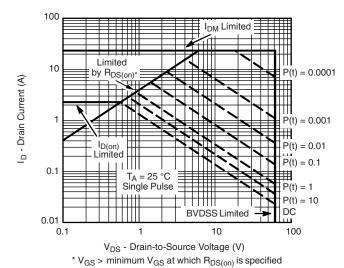
On-Resistance vs. Gate-to-Source Voltage



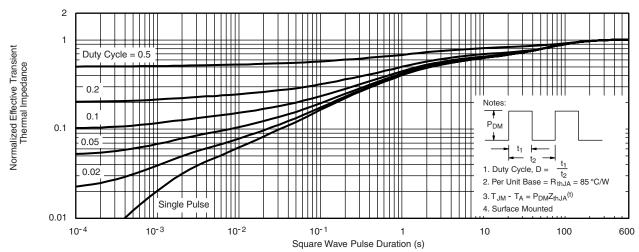
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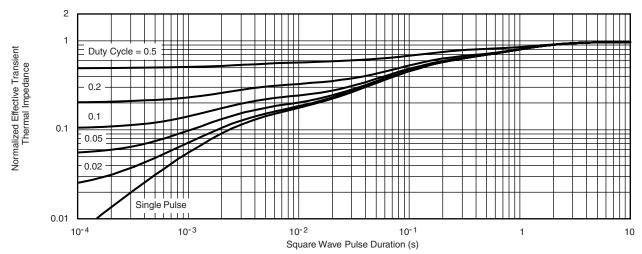
Safe Operating Area, Junction-to-Case



Normalized Thermal Transient Impedance, Junction-to-Ambient



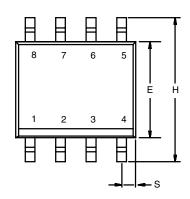
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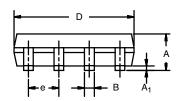


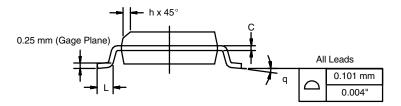
Normalized Thermal Transient Impedance, Junction-to-Foot



SOIC (NARROW): 8-LEAD JEDEC Part Number: MS-012





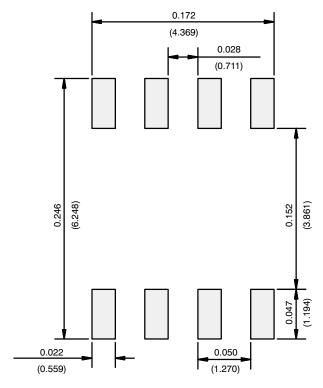


	MILLIM	IETERS	INC	HES		
DIM	Min	Max	Min	Max		
Α	1.35	1.75	0.053	0.069		
A ₁	0.10	0.20	0.004	0.008		
В	0.35	0.51	0.014	0.020		
С	0.19	0.25	0.0075	0.010		
D	4.80	5.00	0.189	0.196		
Е	3.80	4.00	0.150	0.157		
е	1.27	BSC	0.050 BSC			
Н	5.80	6.20	0.228	0.244		
h	0.25	0.50	0.010	0.020		
L	0.50	0.93	0.020	0.037		
q	0°	8°	0°	8°		
S	0.44	0.64	0.018	0.026		
ECN: C-06527-Rev I 11-Sep-06						

ECN: C-06527-Rev. I, 11-Sep-06

DWG: 5498

RECOMMENDED MINIMUM PADS FOR SO-8



Recommended Minimum Pads Dimensions in Inches/(mm)

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